

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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HI1612X560R-10

UNCONTROLLED DOCUMENT

PHYSICAL DIMENSIONS:

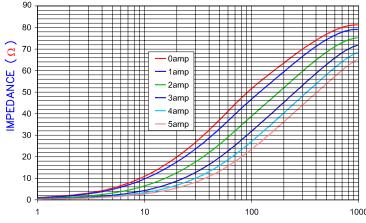
A 4.06 [.160] ± 0.20 [.008]

B 3.05 [.120] ± 0.20 [.008]

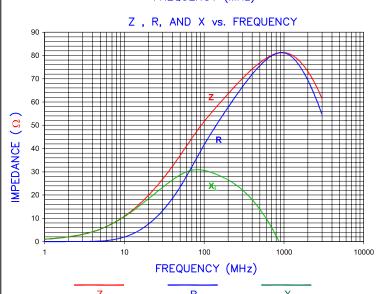
C 2.28 [.090] ± 0.20 [.008]

D 0.70 [.028] ± 0.25 [.010]

Z vs FREQUENCY IMPEDANCE UNDER DC BIAS

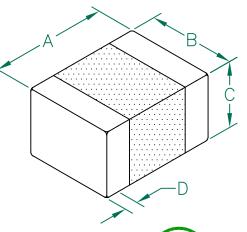


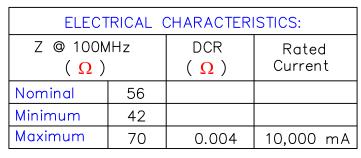
FREQUENCY (MHz)



AGILENT E4991A RF Impedance/Material Analyzer

HP 16194A Test Fixture. TEST REF. 3236

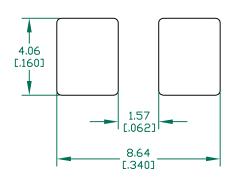




NOTES: UNLESS OTHERWISE SPECIFIED

- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 13" REELS, 2,500 PCS/REEL.
- 2. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 3. TERMINATION FINISH IS 100% TIN.
- 4. OPERATEING TEMPERATURE TEMP: -40°C~+125°C (INCLUDING SELF-HEATING)

LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.762 [.030] to this dimension.)

ORIGINAL DRAFT

DESCRIPTION

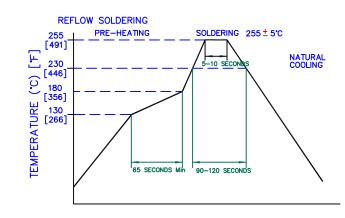
RECOMMENDED SOLDERING CONDITIONS

CO-FIRE

NTS

SHEET:

2 of 2



HI1612X560R-10-G



DIMENSIONS ARE IN mm [INCHES].				This print is the property of La	ird	
				Tech, and is loaned in confiden subject to return upon request		4
	ADD OPERATING TEMPERATURE UPDATE LAIRD LOGO AND REFLOW CURVE	08/05/13	QU	with the understanding that no copies shall be made without the written consent of Laird Tech.	he	•
	UPDATE D DIMENSION	03/12/10	JUN	rights to design or invention ar		
	UPDATE COMPANY LOGO	06/15/09	JRK	reserved.		_
	UPDATE COMPANY LOGO	01/18/08	JRK	PROJECT/PART NUMBER:		l
	CHANGE TOLERANCE ON D DIMENSION	08/29/06	JRK	HI1612X560R-10		l
	CHANGE D DIMENSION & TOLERANCE	03/21/06	JRK	DATE: 09/19/05	SC	N
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09/19/05 JRK

DATE